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MMBT2222A

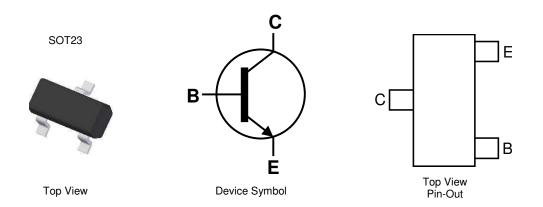
40V NPN SMALL SIGNAL TRANSISTOR IN SOT23

Features

- Epitaxial Planar Die Construction
- Complementary PNP Type: MMBT2907A
- Ideal for Low Power Amplification and Switching
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)



Ordering Information (Notes 4 & 5)

| Product | Status | Compliance | Marking | Reel Size (inches) | Tape Width (mm) | Quantity per Reel |
|----------------|--------|------------|---------|--------------------|-----------------|-------------------|
| MMBT2222A-7-F | Active | AEC-Q101 | K1P | 7 | 8 | 3,000 |
| MMBT2222A-13-F | Active | AEC-Q101 | K1P | 13 | 8 | 10,000 |
| MMBT2222AQ-7-F | Active | Automotive | K1P | 7 | 8 | 3,000 |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

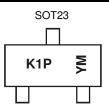
3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/product_compliance_definitions.html.

For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



 $\begin{array}{l} \mathsf{K1P}=\mathsf{Product Type Marking Code} \\ \mathsf{YM}=\mathsf{Date Code Marking} \\ \mathsf{Y or }\overline{\mathsf{Y}}=\mathsf{Year} \ (ex: \mathsf{D}=2016) \\ \mathsf{M or }\overline{\mathsf{M}}=\mathsf{Month} \ (ex: 9=\mathsf{September}) \end{array}$

| Date Code Key | | | | | | | | | | | | |
|---------------|-----|-----|-----|------|------|------|------|-----|------|-----|------|------|
| Year | 201 | 5 2 | 016 | 2017 | 2018 | 2019 | 2020 | 202 | 21 2 | 022 | 2023 | 2024 |
| Code | С | | D | E | F | G | Н | | | J | K | L |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|---------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CBO} | 75 | V |
| Collector-Emitter Voltage | V _{CEO} | 40 | V |
| Emitter-Base Voltage | V _{EBO} | 6.0 | V |
| Collector Current | lc | 600 | mA |
| Peak Collector Current | ICM | 800 | mA |
| Peak Base Current | I _{BM} | 200 | mA |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|--|----------------------------------|------------------|------|---------------|
| Collector Dewar Dissinction | (Note 6) | D | 310 | mW |
| Collector Power Dissipation | (Note 7) | P _D | 350 | IIIVV |
| Thermal Desistance, lunction to Ambient | (Note 6) | P | 403 | 0 0 M/ |
| Thermal Resistance, Junction to Ambient | (Note 7) | R _{0JA} | 357 | °C/W |
| Thermal Resistance, Junction to Leads (Note 8) | | R _{θJL} | 350 | °C/W |
| Operating and Storage Temperature Range | T _{J,} T _{STG} | -55 to +150 | °C | |

ESD Ratings (Note 9)

| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V | 3A |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | С |

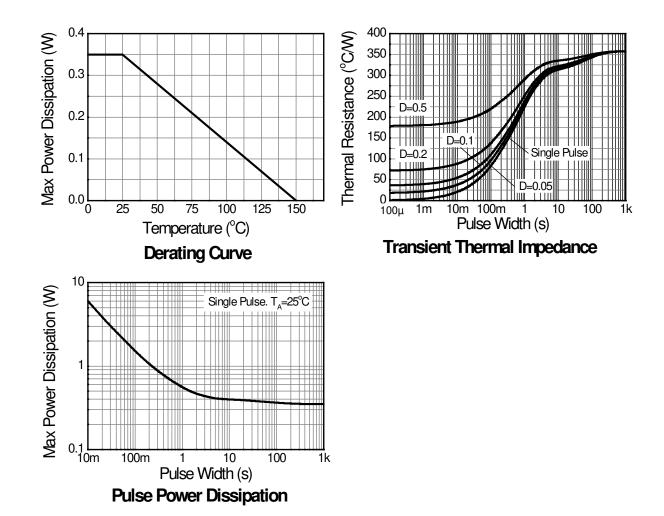
6. For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR-4 PCB; device is measured under still air Notes: conditions whilst operating in a steady-state.

7. Same as Note 6, except the device is mounted on 15 mm x 15mm 1oz copper.

Thermal resistance from junction to solder-point (at the end of the leads).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





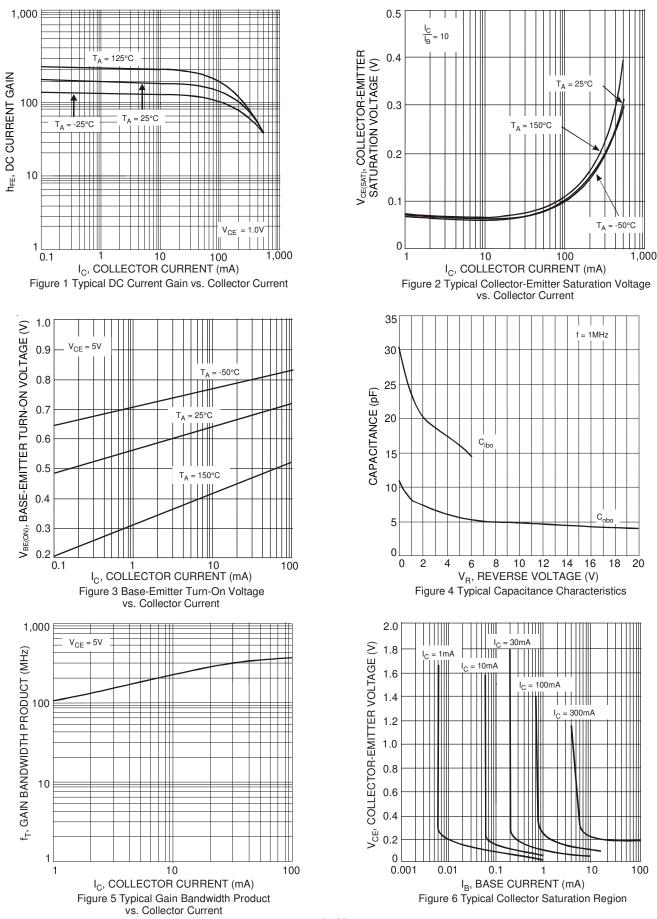
Electrical Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | Symbol | Min | Max | Unit | Test Condition |
|---|----------------------|---|-------------|----------|--|
| OFF CHARACTERISTICS | | | • | • | • |
| Collector-Base Breakdown Voltage | BV _{CBO} | 75 | | V | $I_{C} = 100 \mu A, I_{E} = 0$ |
| Collector-Emitter Breakdown Voltage (Note 10) | BV _{CEO} | 40 | | V | $I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$ |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 6.0 | _ | V | $I_{E} = 100 \mu A, I_{C} = 0$ |
| Collector Cut-Off Current | I _{CBO} | _ | 10 | nA μA | $V_{CB} = 60V, I_E = 0$ $V_{CB} = 60V, I_E = 0, T_A = +150^{\circ}C$ |
| Collector Cut-Off Current | ICEX | | 10 | nA | $V_{CE} = 60V, V_{EB(OFF)} = 3.0V$ |
| Collector Cut-Off Current | ICEV | _ | 10 | nA | $V_{CE} = 60V, V_{BE} = \pm 0.25V$ |
| Emitter Cut-Off Current | I _{EBO} | _ | 10 | nA | $V_{EB} = 5.0V, I_{C} = 0$ |
| Base Cut-Off Current | I _{BL} | _ | 20 | nA | $V_{CE} = 60V, V_{EB(OFF)} = 3.0V$ |
| ON CHARACTERISTICS (Note 10) | | | • | • | · |
| DC Current Gain | h _{FE} | 35 50 75 100 40 50 35 | 300 | | $\begin{split} I_{C} &= 100\mu A, \ V_{CE} = 10V \\ I_{C} &= 1.0mA, \ V_{CE} = 10V \\ I_{C} &= 10mA, \ V_{CE} = 10V \\ I_{C} &= 150mA, \ V_{CE} = 10V \\ I_{C} &= 500mA, \ V_{CE} = 10V \\ I_{C} &= 10mA, \ V_{CE} = 10V, \ T_{A} = -55^{\circ}C \\ I_{C} &= 150mA, \ V_{CE} = 1.0V \end{split}$ |
| Collector-Emitter Saturation Voltage | V _{CE(SAT)} | _ | 0.3 1.0 | v | $I_{C} = 150mA, I_{B} = 15mA$ $I_{C} = 500mA, I_{B} = 50mA$ |
| Base-Emitter Saturation Voltage | V _{BE(SAT)} | 0.6 | 1.2 2.0 | V | $I_{C} = 150$ mA, $I_{B} = 15$ mA $I_{C} = 500$ mA, $I_{B} = 50$ mA |
| SMALL SIGNAL CHARACTERISTICS | | | • | • | • |
| Output Capacitance | Cobo | _ | 8 | pF | V _{CB} = 10V, f = 1.0MHz, I _E = 0 |
| Input Capacitance | Cibo | _ | 25 | pF | V _{EB} = 0.5V, f = 1.0MHz, I _C = 0 |
| Current Gain-Bandwidth Product | f⊤ | 300 | _ | MHz | $V_{CE} = 20V, I_C = 20mA, f = 100MHz$ |
| Noise Figure | N _F | _ | 4.0 | dB | $V_{CE} = 10V, I_C = 100\mu A,$ $R_S = 1.0k\Omega, f = 1.0kHz$ |
| SWITCHING CHARACTERISTICS | | | • | • | · |
| Delay Time | tD | | 10 | ns | $V_{CC} = 30V, I_C = 150mA, V_{BE(OFF)} = -0.5V, I_{B1} = 15mA$ |
| Rise Time | t _R | _ | 25 | ns | $\label{eq:VCC} \begin{array}{l} V_{CC}=3.0V,\ I_{C}=150mA,\ I_{B1}=15mA,\\ V_{BE(OFF)}=0.5V \end{array}$ |
| Storage Time | ts | | 225 | ns | $V_{CC} = 30V, I_C = 150mA,$ $I_{B1} = I_{B2} = 15mA$ |
| Fall Time | tF | | 60 | ns | V _{CC} = 30V, I _C = 150mA, I _{B1} = I _{B2} = 15mA |

Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.







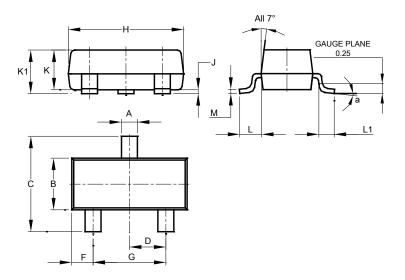
MMBT2222A Document number: DS30041 Rev. 16 - 2 5 of 7 www.diodes.com April 2016 © Diodes Incorporated



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



| | SOT23 | | | | | | | |
|-----|--------|---------|-------|--|--|--|--|--|
| Dim | Min | Max | Тур | | | | | |
| Α | 0.37 | 0.51 | 0.40 | | | | | |
| В | 1.20 | 1.40 | 1.30 | | | | | |
| С | 2.30 | 2.50 | 2.40 | | | | | |
| D | 0.89 | 1.03 | 0.915 | | | | | |
| F | 0.45 | 0.60 | 0.535 | | | | | |
| G | 1.78 | 2.05 | 1.83 | | | | | |
| н | 2.80 | 3.00 | 2.90 | | | | | |
| J | 0.013 | 0.10 | 0.05 | | | | | |
| К | 0.890 | 1.00 | 0.975 | | | | | |
| K1 | 0.903 | 1.10 | 1.025 | | | | | |
| L | 0.45 | 0.61 | 0.55 | | | | | |
| L1 | 0.25 | 0.55 | 0.40 | | | | | |
| М | 0.085 | 0.150 | 0.110 | | | | | |
| а | 0° | 8° | | | | | | |
| All | Dimens | ions in | mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

]_____

SOT23

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|-------|----------------------|--|
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| | │ | |
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| - X - | ×1 | |

| Dimensions | Value (in mm) |
|------------|---------------|
| С | 2.0 |
| Х | 0.8 |
| X1 | 1.35 |
| Y | 0.9 |
| Y1 | 2.9 |



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